



Welcome to [E-XFL.COM](https://www.e-xfl.com)

### Understanding [Embedded - CPLDs \(Complex Programmable Logic Devices\)](#)

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixed-function ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

### Applications of Embedded - CPLDs

#### Details

|                                 |   |
|---------------------------------|---|
| Product Status                  | Obsolete  |
| Programmable Type               | In System Programmable  |
| Delay Time tpd(1) Max           | 10 ns   |
| Voltage Supply - Internal       | 3V ~ 3.6V   |
| Number of Logic Elements/Blocks | 4   |
| Number of Macrocells            | 64  |
| Number of Gates                 | 1250  |
| Number of I/O                   | 68  |
| Operating Temperature           | 0°C ~ 70°C (TA)   |
| Mounting Type                   | Surface Mount   |
| Package / Case                  | 100-LBGA  |
| Supplier Device Package         | 100-FBGA (11x11)  |
| Purchase URL                    | <a href="https://www.e-xfl.com/product-detail/intel/epm7064aefc100-10">https://www.e-xfl.com/product-detail/intel/epm7064aefc100-10</a> |

**Table 1. MAX 7000A Device Features**

| Feature               | EPM7032AE | EPM7064AE | EPM7128AE | EPM7256AE | EPM7512AE |
|-----------------------|-----------|-----------|-----------|-----------|-----------|
| Usable gates          | 600       | 1,250     | 2,500     | 5,000     | 10,000    |
| Macrocells            | 32        | 64        | 128       | 256       | 512       |
| Logic array blocks    | 2         | 4         | 8         | 16        | 32        |
| Maximum user I/O pins | 36        | 68        | 100       | 164       | 212       |
| $t_{PD}$ (ns)         | 4.5       | 4.5       | 5.0       | 5.5       | 7.5       |
| $t_{SU}$ (ns)         | 2.9       | 2.8       | 3.3       | 3.9       | 5.6       |
| $t_{FSU}$ (ns)        | 2.5       | 2.5       | 2.5       | 2.5       | 3.0       |
| $t_{CO1}$ (ns)        | 3.0       | 3.1       | 3.4       | 3.5       | 4.7       |
| $f_{CNT}$ (MHz)       | 227.3     | 222.2     | 192.3     | 172.4     | 116.3     |

## ...and More Features

- 4.5-ns pin-to-pin logic delays with counter frequencies of up to 227.3 MHz
- MultiVolt™ I/O interface enables device core to run at 3.3 V, while I/O pins are compatible with 5.0-V, 3.3-V, and 2.5-V logic levels
- Pin counts ranging from 44 to 256 in a variety of thin quad flat pack (TQFP), plastic quad flat pack (PQFP), ball-grid array (BGA), space-saving FineLine BGA™, and plastic J-lead chip carrier (PLCC) packages
- Supports hot-socketing in MAX 7000AE devices
- Programmable interconnect array (PIA) continuous routing structure for fast, predictable performance
- PCI-compatible
- Bus-friendly architecture, including programmable slew-rate control
- Open-drain output option
- Programmable macrocell registers with individual clear, preset, clock, and clock enable controls
- Programmable power-up states for macrocell registers in MAX 7000AE devices
- Programmable power-saving mode for 50% or greater power reduction in each macrocell
- Configurable expander product-term distribution, allowing up to 32 product terms per macrocell
- Programmable security bit for protection of proprietary designs
- 6 to 10 pin- or logic-driven output enable signals
- Two global clock signals with optional inversion
- Enhanced interconnect resources for improved routability
- Fast input setup times provided by a dedicated path from I/O pin to macrocell registers
- Programmable output slew-rate control
- Programmable ground pins

MAX 7000A devices use CMOS EEPROM cells to implement logic functions. The user-configurable MAX 7000A architecture accommodates a variety of independent combinatorial and sequential logic functions. The devices can be reprogrammed for quick and efficient iterations during design development and debug cycles, and can be programmed and erased up to 100 times.

MAX 7000A devices contain from 32 to 512 macrocells that are combined into groups of 16 macrocells, called logic array blocks (LABs). Each macrocell has a programmable-AND/fixed-OR array and a configurable register with independently programmable clock, clock enable, clear, and preset functions. To build complex logic functions, each macrocell can be supplemented with both shareable expander product terms and high-speed parallel expander product terms, providing up to 32 product terms per macrocell.

MAX 7000A devices provide programmable speed/power optimization. Speed-critical portions of a design can run at high speed/full power, while the remaining portions run at reduced speed/low power. This speed/power optimization feature enables the designer to configure one or more macrocells to operate at 50% or lower power while adding only a nominal timing delay. MAX 7000A devices also provide an option that reduces the slew rate of the output buffers, minimizing noise transients when non-speed-critical signals are switching. The output drivers of all MAX 7000A devices can be set for 2.5 V or 3.3 V, and all input pins are 2.5-V, 3.3-V, and 5.0-V tolerant, allowing MAX 7000A devices to be used in mixed-voltage systems.

MAX 7000A devices are supported by Altera development systems, which are integrated packages that offer schematic, text—including VHDL, Verilog HDL, and the Altera Hardware Description Language (AHDL)—and waveform design entry, compilation and logic synthesis, simulation and timing analysis, and device programming. The software provides EDIF 2.0.0 and 3.0.0, LPM, VHDL, Verilog HDL, and other interfaces for additional design entry and simulation support from other industry-standard PC- and UNIX-workstation-based EDA tools. The software runs on Windows-based PCs, as well as Sun SPARCstation, and HP 9000 Series 700/800 workstations.



For more information on development tools, see the *MAX+PLUS II Programmable Logic Development System & Software Data Sheet* and the *Quartus Programmable Logic Development System & Software Data Sheet*.

## Functional Description

The MAX 7000A architecture includes the following elements:

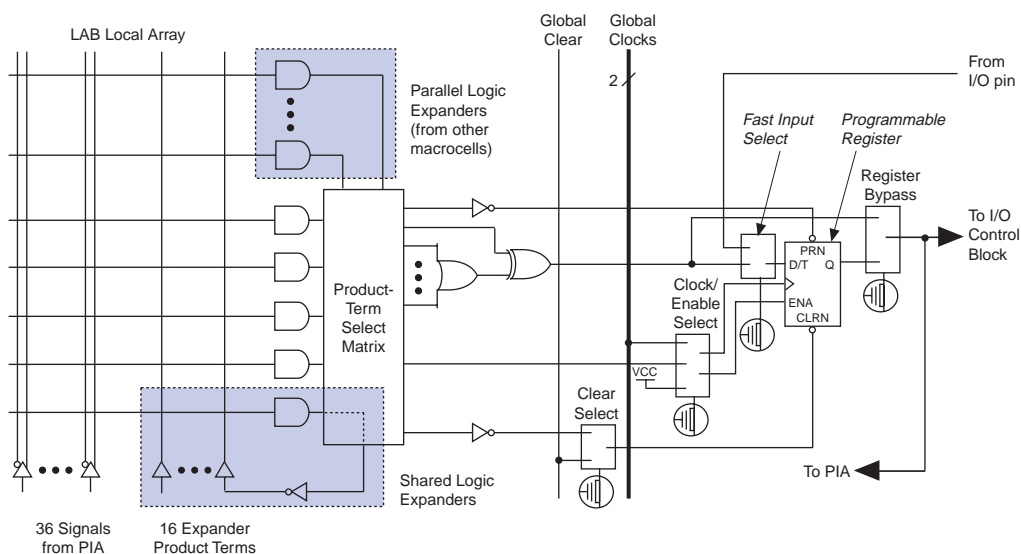
- Logic array blocks (LABs)
- Macrocells
- Expander product terms (shareable and parallel)
- Programmable interconnect array
- I/O control blocks

The MAX 7000A architecture includes four dedicated inputs that can be used as general-purpose inputs or as high-speed, global control signals (clock, clear, and two output enable signals) for each macrocell and I/O pin. [Figure 1](#) shows the architecture of MAX 7000A devices.

## Macrocells

MAX 7000A macrocells can be individually configured for either sequential or combinatorial logic operation. The macrocells consist of three functional blocks: the logic array, the product-term select matrix, and the programmable register. **Figure 2** shows a MAX 7000A macrocell.

**Figure 2. MAX 7000A Macrocell**



Combinatorial logic is implemented in the logic array, which provides five product terms per macrocell. The product-term select matrix allocates these product terms for use as either primary logic inputs (to the OR and XOR gates) to implement combinatorial functions, or as secondary inputs to the macrocell's register preset, clock, and clock enable control functions.

Two kinds of expander product terms ("expanders") are available to supplement macrocell logic resources:

- Shareable expanders, which are inverted product terms that are fed back into the logic array
- Parallel expanders, which are product terms borrowed from adjacent macrocells

The Altera development system automatically optimizes product-term allocation according to the logic requirements of the design.

For registered functions, each macrocell flipflop can be individually programmed to implement D, T, JK, or SR operation with programmable clock control. The flipflop can be bypassed for combinatorial operation. During design entry, the designer specifies the desired flipflop type; the Altera software then selects the most efficient flipflop operation for each registered function to optimize resource utilization.

Each programmable register can be clocked in three different modes:

- Global clock signal. This mode achieves the fastest clock-to-output performance.
- Global clock signal enabled by an active-high clock enable. A clock enable is generated by a product term. This mode provides an enable on each flipflop while still achieving the fast clock-to-output performance of the global clock.
- Array clock implemented with a product term. In this mode, the flipflop can be clocked by signals from buried macrocells or I/O pins.

Two global clock signals are available in MAX 7000A devices. As shown in [Figure 1](#), these global clock signals can be the true or the complement of either of the global clock pins, GCLK1 or GCLK2.

Each register also supports asynchronous preset and clear functions. As shown in [Figure 2](#), the product-term select matrix allocates product terms to control these operations. Although the product-term-driven preset and clear from the register are active high, active-low control can be obtained by inverting the signal within the logic array. In addition, each register clear function can be individually driven by the active-low dedicated global clear pin (GCLRn). Upon power-up, each register in a MAX 7000AE device may be set to either a high or low state. This power-up state is specified at design entry. Upon power-up, each register in EPM7128A and EPM7256A devices are set to a low state.

All MAX 7000A I/O pins have a fast input path to a macrocell register. This dedicated path allows a signal to bypass the PIA and combinatorial logic and be clocked to an input D flipflop with an extremely fast (as low as 2.5 ns) input setup time.

## In-System Programmability

MAX 7000A devices can be programmed in-system via an industry-standard 4-pin IEEE Std. 1149.1 (JTAG) interface. ISP offers quick, efficient iterations during design development and debugging cycles. The MAX 7000A architecture internally generates the high programming voltages required to program EEPROM cells, allowing in-system programming with only a single 3.3-V power supply. During in-system programming, the I/O pins are tri-stated and weakly pulled-up to eliminate board conflicts. The pull-up value is nominally 50 k $\Omega$ .

MAX 7000AE devices have an enhanced ISP algorithm for faster programming. These devices also offer an ISP\_Done bit that provides safe operation when in-system programming is interrupted. This ISP\_Done bit, which is the last bit programmed, prevents all I/O pins from driving until the bit is programmed. This feature is only available in EPM7032AE, EPM7064AE, EPM7128AE, EPM7256AE, and EPM7512AE devices.

ISP simplifies the manufacturing flow by allowing devices to be mounted on a PCB with standard pick-and-place equipment before they are programmed. MAX 7000A devices can be programmed by downloading the information via in-circuit testers, embedded processors, the Altera MasterBlaster serial/USB communications cable, ByteBlasterMV parallel port download cable, and BitBlaster serial download cable. Programming the devices after they are placed on the board eliminates lead damage on high-pin-count packages (e.g., QFP packages) due to device handling. MAX 7000A devices can be reprogrammed after a system has already shipped to the field. For example, product upgrades can be performed in the field via software or modem.

In-system programming can be accomplished with either an adaptive or constant algorithm. An adaptive algorithm reads information from the unit and adapts subsequent programming steps to achieve the fastest possible programming time for that unit. A constant algorithm uses a pre-defined (non-adaptive) programming sequence that does not take advantage of adaptive algorithm programming time improvements. Some in-circuit testers cannot program using an adaptive algorithm. Therefore, a constant algorithm must be used. MAX 7000AE devices can be programmed with either an adaptive or constant (non-adaptive) algorithm. EPM7128A and EPM7256A device can only be programmed with an adaptive algorithm; users programming these two devices on platforms that cannot use an adaptive algorithm should use EPM7128AE and EPM7256AE devices.

The Jam Standard Test and Programming Language (STAPL), JEDEC standard JESD 71, can be used to program MAX 7000A devices with in-circuit testers, PCs, or embedded processors.

The programming times described in [Tables 5 through 7](#) are associated with the worst-case method using the enhanced ISP algorithm.

**Table 5. MAX 7000A  $t_{PULSE}$  &  $Cycle_{TCK}$  Values**

| Device       | Programming      |                | Stand-Alone Verification |                |
|--------------|------------------|----------------|--------------------------|----------------|
|              | $t_{PPULSE}$ (s) | $Cycle_{PTCK}$ | $t_{VPULSE}$ (s)         | $Cycle_{VTCK}$ |
| EPM7032AE    | 2.00             | 55,000         | 0.002                    | 18,000         |
| EPM7064AE    | 2.00             | 105,000        | 0.002                    | 35,000         |
| EPM7128AE    | 2.00             | 205,000        | 0.002                    | 68,000         |
| EPM7256AE    | 2.00             | 447,000        | 0.002                    | 149,000        |
| EPM7512AE    | 2.00             | 890,000        | 0.002                    | 297,000        |
| EPM7128A (1) | 5.11             | 832,000        | 0.03                     | 528,000        |
| EPM7256A (1) | 6.43             | 1,603,000      | 0.03                     | 1,024,000      |

[Tables 6 and 7](#) show the in-system programming and stand alone verification times for several common test clock frequencies.

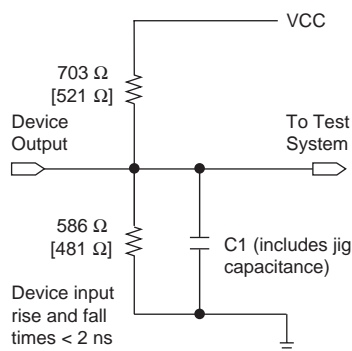
**Table 6. MAX 7000A In-System Programming Times for Different Test Clock Frequencies**

| Device       | $f_{TCK}$ |       |       |       |         |         |         |        | Units |
|--------------|-----------|-------|-------|-------|---------|---------|---------|--------|-------|
|              | 10 MHz    | 5 MHz | 2 MHz | 1 MHz | 500 kHz | 200 kHz | 100 kHz | 50 kHz |       |
| EPM7032AE    | 2.01      | 2.01  | 2.03  | 2.06  | 2.11    | 2.28    | 2.55    | 3.10   | s     |
| EPM7064AE    | 2.01      | 2.02  | 2.05  | 2.11  | 2.21    | 2.53    | 3.05    | 4.10   | s     |
| EPM7128AE    | 2.02      | 2.04  | 2.10  | 2.21  | 2.41    | 3.03    | 4.05    | 6.10   | s     |
| EPM7256AE    | 2.05      | 2.09  | 2.23  | 2.45  | 2.90    | 4.24    | 6.47    | 10.94  | s     |
| EPM7512AE    | 2.09      | 2.18  | 2.45  | 2.89  | 3.78    | 6.45    | 10.90   | 19.80  | s     |
| EPM7128A (1) | 5.19      | 5.27  | 5.52  | 5.94  | 6.77    | 9.27    | 13.43   | 21.75  | s     |
| EPM7256A (1) | 6.59      | 6.75  | 7.23  | 8.03  | 9.64    | 14.45   | 22.46   | 38.49  | s     |



**Figure 9. MAX 7000A AC Test Conditions**

Power supply transients can affect AC measurements. Simultaneous transitions of multiple outputs should be avoided for accurate measurement. Threshold tests must not be performed under AC conditions. Large-amplitude, fast-ground-current transients normally occur as the device outputs discharge the load capacitances. When these transients flow through the parasitic inductance between the device ground pin and the test system ground, significant reductions in observable noise immunity can result. Numbers in brackets are for 2.5-V outputs. Numbers without brackets are for 3.3-V outputs.



## Operating Conditions

Tables 13 through 16 provide information on absolute maximum ratings, recommended operating conditions, operating conditions, and capacitance for MAX 7000A devices.

**Table 13. MAX 7000A Device Absolute Maximum Ratings** *Note (1)*

| Symbol    | Parameter                  | Conditions   | Min  | Max  | Unit |
|-----------|----------------------------|--|------|------|------|
| $V_{CC}$  | Supply voltage             | With respect to ground (2)                             | -0.5 | 4.6  | V    |
| $V_I$     | DC input voltage           |  | -2.0 | 5.75 | V    |
| $I_{OUT}$ | DC output current, per pin |  | -25  | 25   | mA   |
| $T_{STG}$ | Storage temperature        | No bias  | -65  | 150  | °C   |
| $T_A$     | Ambient temperature        | Under bias   | -65  | 135  | °C   |
| $T_J$     | Junction temperature       | BGA, FineLine BGA, PQFP, and TQFP packages, under bias |      | 135  | °C   |

**Table 15. MAX 7000A Device DC Operating Conditions** *Note (6)*

| Symbol    | Parameter   | Conditions  | Min              | Max  | Unit       |
|-----------|---|---|------------------|------|------------|
| $V_{IH}$  | High-level input voltage  |   | 1.7              | 5.75 | V          |
| $V_{IL}$  | Low-level input voltage   |   | -0.5             | 0.8  | V          |
| $V_{OH}$  | 3.3-V high-level TTL output voltage   | $I_{OH} = -8$ mA DC, $V_{CCIO} = 3.00$ V (7)        | 2.4              |      | V          |
|           | 3.3-V high-level CMOS output voltage  | $I_{OH} = -0.1$ mA DC, $V_{CCIO} = 3.00$ V (7)      | $V_{CCIO} - 0.2$ |      | V          |
|           | 2.5-V high-level output voltage   | $I_{OH} = -100$ $\mu$ A DC, $V_{CCIO} = 2.30$ V (7) | 2.1              |      | V          |
|           |   | $I_{OH} = -1$ mA DC, $V_{CCIO} = 2.30$ V (7)        | 2.0              |      | V          |
|           |   | $I_{OH} = -2$ mA DC, $V_{CCIO} = 2.30$ V (7)        | 1.7              |      | V          |
| $V_{OL}$  | 3.3-V low-level TTL output voltage  | $I_{OL} = 8$ mA DC, $V_{CCIO} = 3.00$ V (8)         |                  | 0.45 | V          |
|           | 3.3-V low-level CMOS output voltage   | $I_{OL} = 0.1$ mA DC, $V_{CCIO} = 3.00$ V (8)       |                  | 0.2  | V          |
|           | 2.5-V low-level output voltage  | $I_{OL} = 100$ $\mu$ A DC, $V_{CCIO} = 2.30$ V (8)  |                  | 0.2  | V          |
|           |   | $I_{OL} = 1$ mA DC, $V_{CCIO} = 2.30$ V (8)         |                  | 0.4  | V          |
|           |   | $I_{OL} = 2$ mA DC, $V_{CCIO} = 2.30$ V (8)         |                  | 0.7  | V          |
| $I_I$     | Input leakage current   | $V_I = -0.5$ to $5.5$ V (9)                         | -10              | 10   | $\mu$ A    |
| $I_{OZ}$  | Tri-state output off-state current  | $V_I = -0.5$ to $5.5$ V (9)                         | -10              | 10   | $\mu$ A    |
| $R_{ISP}$ | Value of I/O pin pull-up resistor during in-system programming or during power-up | $V_{CCIO} = 3.0$ to $3.6$ V (10)                    | 20               | 50   | k $\Omega$ |
|           |   | $V_{CCIO} = 2.3$ to $2.7$ V (10)                    | 30               | 80   | k $\Omega$ |
|           |   | $V_{CCIO} = 2.3$ to $3.6$ V (11)                    | 20               | 74   | k $\Omega$ |

**Table 16. MAX 7000A Device Capacitance** *Note (12)*

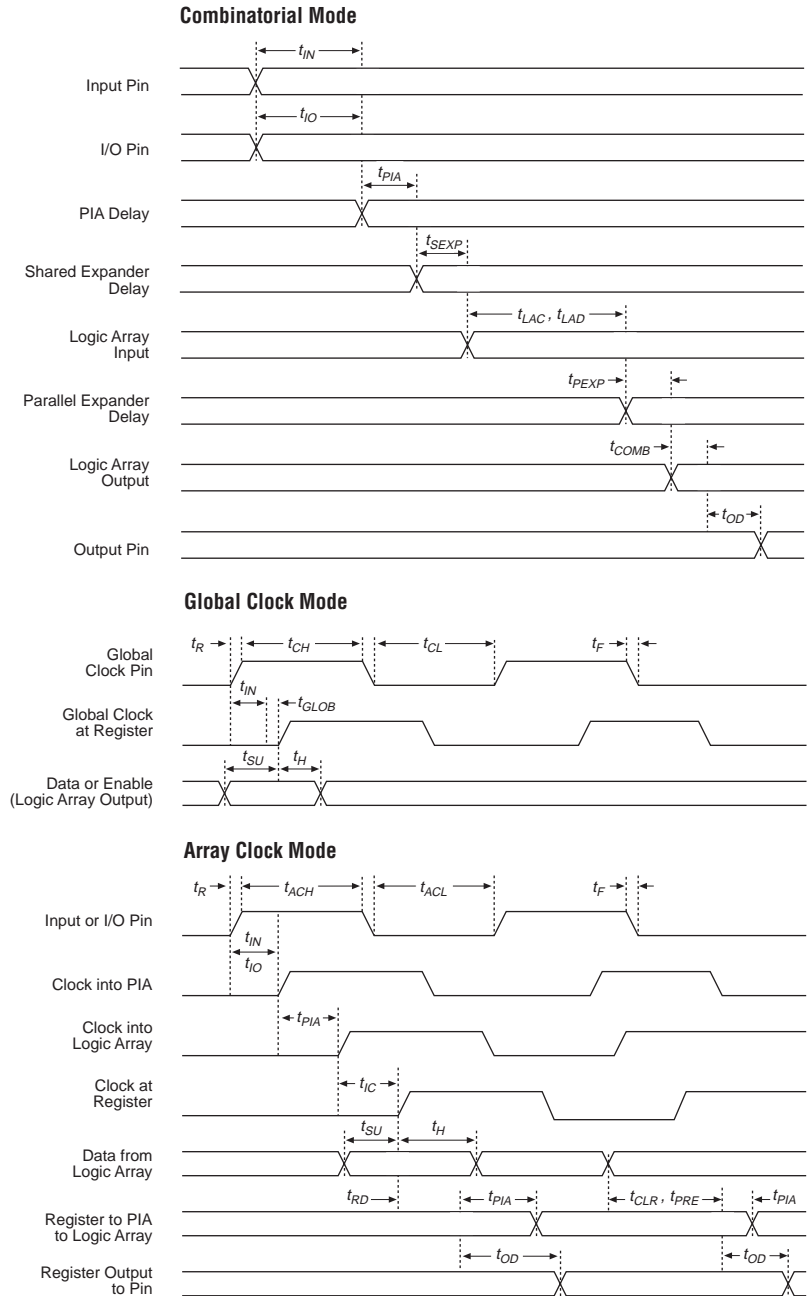
| Symbol    | Parameter             | Conditions                     | Min | Max | Unit |
|-----------|-----------------------|--------------------------------|-----|-----|------|
| $C_{IN}$  | Input pin capacitance | $V_{IN} = 0$ V, $f = 1.0$ MHz  |     | 8   | pF   |
| $C_{I/O}$ | I/O pin capacitance   | $V_{OUT} = 0$ V, $f = 1.0$ MHz |     | 8   | pF   |

### Notes to tables:

- (1) See the *Operating Requirements for Altera Devices Data Sheet*.
- (2) Minimum DC input voltage is  $-0.5$  V. During transitions, the inputs may undershoot to  $-2.0$  V for input currents less than 100 mA and periods shorter than 20 ns.
- (3) For EPM7128A and EPM7256A devices only,  $V_{CC}$  must rise monotonically.
- (4) In MAX 7000AE devices, all pins, including dedicated inputs, I/O pins, and JTAG pins, may be driven before  $V_{CCINT}$  and  $V_{CCIO}$  are powered.
- (5) These devices support in-system programming for  $-40^{\circ}$  to  $100^{\circ}$  C. For in-system programming support between  $-40^{\circ}$  and  $0^{\circ}$  C, contact Altera Applications.
- (6) These values are specified under the recommended operating conditions shown in [Table 14 on page 28](#).
- (7) The parameter is measured with 50% of the outputs each sourcing the specified current. The  $I_{OH}$  parameter refers to high-level TTL or CMOS output current.
- (8) The parameter is measured with 50% of the outputs each sinking the specified current. The  $I_{OL}$  parameter refers to low-level TTL or CMOS output current.
- (9) This value is specified for normal device operation. For MAX 7000AE devices, the maximum leakage current during power-up is  $\pm 300$   $\mu$ A. For EPM7128A and EPM7256A devices, leakage current during power-up is not specified.
- (10) For EPM7128A and EPM7256A devices, this pull-up exists while a device is programmed in-system.
- (11) For MAX 7000AE devices, this pull-up exists while devices are programmed in-system and in unprogrammed devices during power-up.
- (12) Capacitance is measured at  $25^{\circ}$  C and is sample-tested only. The  $\odot E1$  pin (high-voltage pin during programming) has a maximum capacitance of 20 pF.
- (13) The POR time for MAX 7000AE devices (except MAX 7128A and MAX 7256A devices) does not exceed 100  $\mu$ s. The sufficient  $V_{CCINT}$  voltage level for POR is 3.0 V. The device is fully initialized within the POR time after  $V_{CCINT}$  reaches the sufficient POR voltage level.

**Figure 12. MAX 7000A Switching Waveforms**

$t_R$  &  $t_F < 2$  ns. Inputs are driven at 3 V for a logic high and 0 V for a logic low. All timing characteristics are measured at 1.5 V.



Tables 17 through 30 show EPM7032AE, EPM7064AE, EPM7128AE, EPM7256AE, EPM7512AE, EPM7128A, and EPM7256A timing information.

**Table 17. EPM7032AE External Timing Parameters** *Note (1)*

| Symbol            | Parameter                                | Conditions     | Speed Grade |     |       |     |       |     | Unit |
|-------------------|--|----------------|-------------|-----|-------|-----|-------|-----|------|
|                   |  |                | -4          |     | -7    |     | -10   |     |      |
|                   |  |                | Min         | Max | Min   | Max | Min   | Max |      |
| t <sub>PD1</sub>  | Input to non-registered output           | C1 = 35 pF (2) |             | 4.5 |       | 7.5 |       | 10  | ns   |
| t <sub>PD2</sub>  | I/O input to non-registered output       | C1 = 35 pF (2) |             | 4.5 |       | 7.5 |       | 10  | ns   |
| t <sub>SU</sub>   | Global clock setup time                  | (2)            | 2.9         |     | 4.7   |     | 6.3   |     | ns   |
| t <sub>H</sub>    | Global clock hold time                   | (2)            | 0.0         |     | 0.0   |     | 0.0   |     | ns   |
| t <sub>FSU</sub>  | Global clock setup time of fast input    |                | 2.5         |     | 3.0   |     | 3.0   |     | ns   |
| t <sub>FH</sub>   | Global clock hold time of fast input     |                | 0.0         |     | 0.0   |     | 0.0   |     | ns   |
| t <sub>CO1</sub>  | Global clock to output delay             | C1 = 35 pF     | 1.0         | 3.0 | 1.0   | 5.0 | 1.0   | 6.7 | ns   |
| t <sub>CH</sub>   | Global clock high time                   |                | 2.0         |     | 3.0   |     | 4.0   |     | ns   |
| t <sub>CL</sub>   | Global clock low time                    |                | 2.0         |     | 3.0   |     | 4.0   |     | ns   |
| t <sub>ASU</sub>  | Array clock setup time                   | (2)            | 1.6         |     | 2.5   |     | 3.6   |     | ns   |
| t <sub>AH</sub>   | Array clock hold time                    | (2)            | 0.3         |     | 0.5   |     | 0.5   |     | ns   |
| t <sub>ACO1</sub> | Array clock to output delay              | C1 = 35 pF (2) | 1.0         | 4.3 | 1.0   | 7.2 | 1.0   | 9.4 | ns   |
| t <sub>ACH</sub>  | Array clock high time                    |                | 2.0         |     | 3.0   |     | 4.0   |     | ns   |
| t <sub>ACL</sub>  | Array clock low time                     |                | 2.0         |     | 3.0   |     | 4.0   |     | ns   |
| t <sub>CPPW</sub> | Minimum pulse width for clear and preset | (3)            | 2.0         |     | 3.0   |     | 4.0   |     | ns   |
| t <sub>CNT</sub>  | Minimum global clock period              | (2)            |             | 4.4 |       | 7.2 |       | 9.7 | ns   |
| f <sub>CNT</sub>  | Maximum internal global clock frequency  | (2), (4)       | 227.3       |     | 138.9 |     | 103.1 |     | MHz  |
| t <sub>ACNT</sub> | Minimum array clock period               | (2)            |             | 4.4 |       | 7.2 |       | 9.7 | ns   |
| f <sub>ACNT</sub> | Maximum internal array clock frequency   | (2), (4)       | 227.3       |     | 138.9 |     | 103.1 |     | MHz  |

**Table 20. EPM7064AE Internal Timing Parameters (Part 2 of 2)** *Note (1)*

| Symbol     | Parameter            | Conditions | Speed Grade |     |     |     |     |     | Unit |
|------------|----------------------|------------|-------------|-----|-----|-----|-----|-----|------|
|            |                      |            | -4          |     | -7  |     | -10 |     |      |
|            |                      |            | Min         | Max | Min | Max | Min | Max |      |
| $t_{EN}$   | Register enable time |            |             | 0.6 |     | 1.0 |     | 1.2 | ns   |
| $t_{GLOB}$ | Global control delay |            |             | 1.0 |     | 1.5 |     | 2.2 | ns   |
| $t_{PRE}$  | Register preset time |            |             | 1.3 |     | 2.1 |     | 2.9 | ns   |
| $t_{CLR}$  | Register clear time  |            |             | 1.3 |     | 2.1 |     | 2.9 | ns   |
| $t_{PIA}$  | PIA delay            | (2)        |             | 1.0 |     | 1.7 |     | 2.3 | ns   |
| $t_{LPA}$  | Low-power adder      | (6)        |             | 3.5 |     | 4.0 |     | 5.0 | ns   |

**Table 21. EPM7128AE External Timing Parameters** *Note (1)*

| Symbol            | Parameter                                | Conditions        | Speed Grade |     |       |     |      |      | Unit |
|-------------------|--|-------------------|-------------|-----|-------|-----|------|------|------|
|                   |  |                   | -5          |     | -7    |     | -10  |      |      |
|                   |  |                   | Min         | Max | Min   | Max | Min  | Max  |      |
| t <sub>PD1</sub>  | Input to non-registered output           | C1 = 35 pF<br>(2) |             | 5.0 |       | 7.5 |      | 10   | ns   |
| t <sub>PD2</sub>  | I/O input to non-registered output       | C1 = 35 pF<br>(2) |             | 5.0 |       | 7.5 |      | 10   | ns   |
| t <sub>SU</sub>   | Global clock setup time                  | (2)               | 3.3         |     | 4.9   |     | 6.6  |      | ns   |
| t <sub>H</sub>    | Global clock hold time                   | (2)               | 0.0         |     | 0.0   |     | 0.0  |      | ns   |
| t <sub>FSU</sub>  | Global clock setup time of fast input    |                   | 2.5         |     | 3.0   |     | 3.0  |      | ns   |
| t <sub>FH</sub>   | Global clock hold time of fast input     |                   | 0.0         |     | 0.0   |     | 0.0  |      | ns   |
| t <sub>CO1</sub>  | Global clock to output delay             | C1 = 35 pF        | 1.0         | 3.4 | 1.0   | 5.0 | 1.0  | 6.6  | ns   |
| t <sub>CH</sub>   | Global clock high time                   |                   | 2.0         |     | 3.0   |     | 4.0  |      | ns   |
| t <sub>CL</sub>   | Global clock low time                    |                   | 2.0         |     | 3.0   |     | 4.0  |      | ns   |
| t <sub>ASU</sub>  | Array clock setup time                   | (2)               | 1.8         |     | 2.8   |     | 3.8  |      | ns   |
| t <sub>AH</sub>   | Array clock hold time                    | (2)               | 0.2         |     | 0.3   |     | 0.4  |      | ns   |
| t <sub>ACO1</sub> | Array clock to output delay              | C1 = 35 pF<br>(2) | 1.0         | 4.9 | 1.0   | 7.1 | 1.0  | 9.4  | ns   |
| t <sub>ACH</sub>  | Array clock high time                    |                   | 2.0         |     | 3.0   |     | 4.0  |      | ns   |
| t <sub>ACL</sub>  | Array clock low time                     |                   | 2.0         |     | 3.0   |     | 4.0  |      | ns   |
| t <sub>CPPW</sub> | Minimum pulse width for clear and preset | (3)               | 2.0         |     | 3.0   |     | 4.0  |      | ns   |
| t <sub>CNT</sub>  | Minimum global clock period              | (2)               |             | 5.2 |       | 7.7 |      | 10.2 | ns   |
| f <sub>CNT</sub>  | Maximum internal global clock frequency  | (2), (4)          | 192.3       |     | 129.9 |     | 98.0 |      | MHz  |
| t <sub>ACNT</sub> | Minimum array clock period               | (2)               |             | 5.2 |       | 7.7 |      | 10.2 | ns   |
| f <sub>ACNT</sub> | Maximum internal array clock frequency   | (2), (4)          | 192.3       |     | 129.9 |     | 98.0 |      | MHz  |

**Table 22. EPM7128AE Internal Timing Parameters (Part 2 of 2)** *Note (1)*

| Symbol     | Parameter            | Conditions | Speed Grade |     |     |     |     |     | Unit |
|------------|----------------------|------------|-------------|-----|-----|-----|-----|-----|------|
|            |                      |            | -5          |     | -7  |     | -10 |     |      |
|            |                      |            | Min         | Max | Min | Max | Min | Max |      |
| $t_{EN}$   | Register enable time |            |             | 0.7 |     | 1.0 |     | 1.3 | ns   |
| $t_{GLOB}$ | Global control delay |            |             | 1.1 |     | 1.6 |     | 2.0 | ns   |
| $t_{PRE}$  | Register preset time |            |             | 1.4 |     | 2.0 |     | 2.7 | ns   |
| $t_{CLR}$  | Register clear time  |            |             | 1.4 |     | 2.0 |     | 2.7 | ns   |
| $t_{PIA}$  | PIA delay            | (2)        |             | 1.4 |     | 2.0 |     | 2.6 | ns   |
| $t_{LPA}$  | Low-power adder      | (6)        |             | 4.0 |     | 4.0 |     | 5.0 | ns   |



**Table 26. EPM7512AE Internal Timing Parameters (Part 1 of 2)** *Note (1)*

| Symbol     | Parameter   | Conditions                 | Speed Grade |     |     |      |     |      | Unit |
|------------|---|----------------------------|-------------|-----|-----|------|-----|------|------|
|            |   |                            | -7          |     | -10 |      | -12 |      |      |
|            |   |                            | Min         | Max | Min | Max  | Min | Max  |      |
| $t_{IN}$   | Input pad and buffer delay  |                            |             | 0.7 |     | 0.9  |     | 1.0  | ns   |
| $t_{IO}$   | I/O input pad and buffer delay  |                            |             | 0.7 |     | 0.9  |     | 1.0  | ns   |
| $t_{FIN}$  | Fast input delay  |                            |             | 3.1 |     | 3.6  |     | 4.1  | ns   |
| $t_{SEXP}$ | Shared expander delay   |                            |             | 2.7 |     | 3.5  |     | 4.4  | ns   |
| $t_{PEXP}$ | Parallel expander delay   |                            |             | 0.4 |     | 0.5  |     | 0.6  | ns   |
| $t_{LAD}$  | Logic array delay   |                            |             | 2.2 |     | 2.8  |     | 3.5  | ns   |
| $t_{LAC}$  | Logic control array delay   |                            |             | 1.0 |     | 1.3  |     | 1.7  | ns   |
| $t_{IOE}$  | Internal output enable delay  |                            |             | 0.0 |     | 0.0  |     | 0.0  | ns   |
| $t_{OD1}$  | Output buffer and pad delay, slow slew rate = off<br>$V_{CCIO} = 3.3\text{ V}$                  | $C1 = 35\text{ pF}$        |             | 1.0 |     | 1.5  |     | 1.7  | ns   |
| $t_{OD2}$  | Output buffer and pad delay, slow slew rate = off<br>$V_{CCIO} = 2.5\text{ V}$                  | $C1 = 35\text{ pF}$<br>(5) |             | 1.5 |     | 2.0  |     | 2.2  | ns   |
| $t_{OD3}$  | Output buffer and pad delay, slow slew rate = on<br>$V_{CCIO} = 2.5\text{ V}$ or $3.3\text{ V}$ | $C1 = 35\text{ pF}$        |             | 6.0 |     | 6.5  |     | 6.7  | ns   |
| $t_{ZX1}$  | Output buffer enable delay, slow slew rate = off<br>$V_{CCIO} = 3.3\text{ V}$                   | $C1 = 35\text{ pF}$        |             | 4.0 |     | 5.0  |     | 5.0  | ns   |
| $t_{ZX2}$  | Output buffer enable delay, slow slew rate = off<br>$V_{CCIO} = 2.5\text{ V}$                   | $C1 = 35\text{ pF}$<br>(5) |             | 4.5 |     | 5.5  |     | 5.5  | ns   |
| $t_{ZX3}$  | Output buffer enable delay, slow slew rate = on<br>$V_{CCIO} = 3.3\text{ V}$                    | $C1 = 35\text{ pF}$        |             | 9.0 |     | 10.0 |     | 10.0 | ns   |
| $t_{XZ}$   | Output buffer disable delay   | $C1 = 5\text{ pF}$         |             | 4.0 |     | 5.0  |     | 5.0  | ns   |
| $t_{SU}$   | Register setup time   |                            | 2.1         |     | 3.0 |      | 3.5 |      | ns   |
| $t_H$      | Register hold time  |                            | 0.6         |     | 0.8 |      | 1.0 |      | ns   |
| $t_{FSU}$  | Register setup time of fast input   |                            | 1.6         |     | 1.6 |      | 1.6 |      | ns   |
| $t_{FH}$   | Register hold time of fast input  |                            | 1.4         |     | 1.4 |      | 1.4 |      | ns   |
| $t_{RD}$   | Register delay  |                            |             | 1.3 |     | 1.7  |     | 2.1  | ns   |
| $t_{COMB}$ | Combinatorial delay   |                            |             | 0.6 |     | 0.8  |     | 1.0  | ns   |

**Table 26. EPM7512AE Internal Timing Parameters (Part 2 of 2)** *Note (1)*

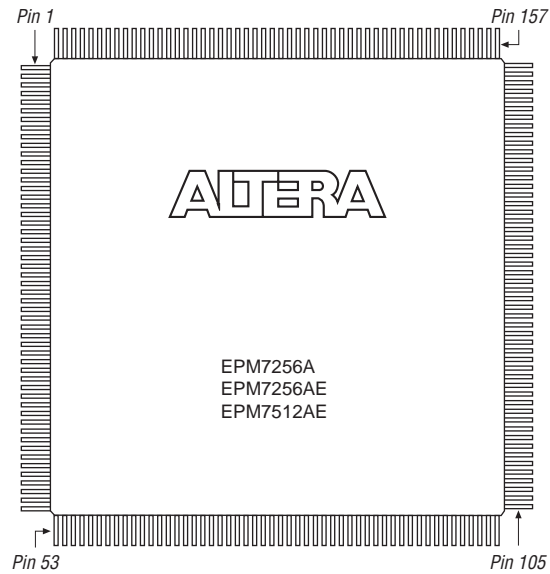
| Symbol     | Parameter            | Conditions | Speed Grade |     |     |     |     |     | Unit |
|------------|----------------------|------------|-------------|-----|-----|-----|-----|-----|------|
|            |                      |            | -7          |     | -10 |     | -12 |     |      |
|            |                      |            | Min         | Max | Min | Max | Min | Max |      |
| $t_{IC}$   | Array clock delay    |            |             | 1.8 |     | 2.3 |     | 2.9 | ns   |
| $t_{EN}$   | Register enable time |            |             | 1.0 |     | 1.3 |     | 1.7 | ns   |
| $t_{GLOB}$ | Global control delay |            |             | 1.7 |     | 2.2 |     | 2.7 | ns   |
| $t_{PRE}$  | Register preset time |            |             | 1.0 |     | 1.4 |     | 1.7 | ns   |
| $t_{CLR}$  | Register clear time  |            |             | 1.0 |     | 1.4 |     | 1.7 | ns   |
| $t_{PIA}$  | PIA delay            | (2)        |             | 3.0 |     | 4.0 |     | 4.8 | ns   |
| $t_{LPA}$  | Low-power adder      | (6)        |             | 4.5 |     | 5.0 |     | 5.0 | ns   |

Table 29. EPM7256A External Timing Parameters *Note (1)*

| Symbol            | Parameter                                | Conditions        | Speed Grade |     |       |     |      |      |      |      | Unit |
|-------------------|--|-------------------|-------------|-----|-------|-----|------|------|------|------|------|
|                   |  |                   | -6          |     | -7    |     | -10  |      | -12  |      |      |
|                   |  |                   | Min         | Max | Min   | Max | Min  | Max  | Min  | Max  |      |
| t <sub>PD1</sub>  | Input to non-registered output           | C1 = 35 pF<br>(2) |             | 6.0 |       | 7.5 |      | 10.0 |      | 12.0 | ns   |
| t <sub>PD2</sub>  | I/O input to non-registered output       | C1 = 35 pF<br>(2) |             | 6.0 |       | 7.5 |      | 10.0 |      | 12.0 | ns   |
| t <sub>SU</sub>   | Global clock setup time                  | (2)               | 3.7         |     | 4.6   |     | 6.2  |      | 7.4  |      | ns   |
| t <sub>H</sub>    | Global clock hold time                   | (2)               | 0.0         |     | 0.0   |     | 0.0  |      | 0.0  |      | ns   |
| t <sub>FSU</sub>  | Global clock setup time of fast input    |                   | 2.5         |     | 3.0   |     | 3.0  |      | 3.0  |      | ns   |
| t <sub>FH</sub>   | Global clock hold time of fast input     |                   | 0.0         |     | 0.0   |     | 0.0  |      | 0.0  |      | ns   |
| t <sub>CO1</sub>  | Global clock to output delay             | C1 = 35 pF        | 1.0         | 3.3 | 1.0   | 4.2 | 1.0  | 5.5  | 1.0  | 6.6  | ns   |
| t <sub>CH</sub>   | Global clock high time                   |                   | 3.0         |     | 3.0   |     | 4.0  |      | 4.0  |      | ns   |
| t <sub>CL</sub>   | Global clock low time                    |                   | 3.0         |     | 3.0   |     | 4.0  |      | 4.0  |      | ns   |
| t <sub>ASU</sub>  | Array clock setup time                   | (2)               | 0.8         |     | 1.0   |     | 1.4  |      | 1.6  |      | ns   |
| t <sub>AH</sub>   | Array clock hold time                    | (2)               | 1.9         |     | 2.7   |     | 4.0  |      | 5.1  |      | ns   |
| t <sub>ACO1</sub> | Array clock to output delay              | C1 = 35 pF<br>(2) | 1.0         | 6.2 | 1.0   | 7.8 | 1.0  | 10.3 | 1.0  | 12.4 | ns   |
| t <sub>ACH</sub>  | Array clock high time                    |                   | 3.0         |     | 3.0   |     | 4.0  |      | 4.0  |      | ns   |
| t <sub>ACL</sub>  | Array clock low time                     |                   | 3.0         |     | 3.0   |     | 4.0  |      | 4.0  |      | ns   |
| t <sub>CPPW</sub> | Minimum pulse width for clear and preset | (3)               | 3.0         |     | 3.0   |     | 4.0  |      | 4.0  |      | ns   |
| t <sub>CNT</sub>  | Minimum global clock period              | (2)               |             | 6.4 |       | 8.0 |      | 10.7 |      | 12.8 | ns   |
| f <sub>CNT</sub>  | Maximum internal global clock frequency  | (2), (4)          | 156.3       |     | 125.0 |     | 93.5 |      | 78.1 |      | MHz  |
| t <sub>ACNT</sub> | Minimum array clock period               | (2)               |             | 6.4 |       | 8.0 |      | 10.7 |      | 12.8 | ns   |
| f <sub>ACNT</sub> | Maximum internal array clock frequency   | (2), (4)          | 156.3       |     | 125.0 |     | 93.5 |      | 78.1 |      | MHz  |

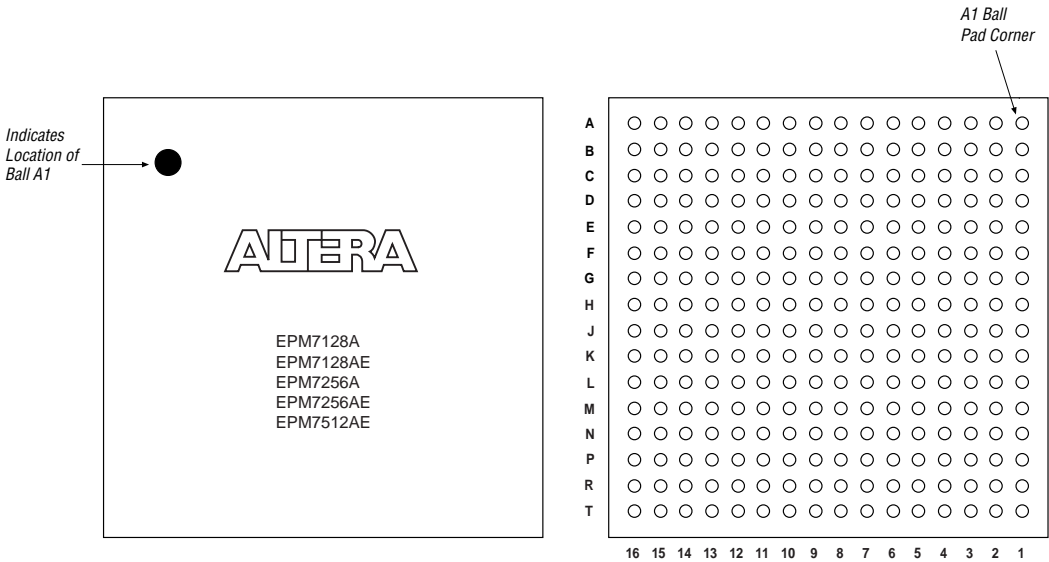
**Figure 21. 208-Pin PQFP Package Pin-Out Diagram**

Package outline not drawn to scale.



**Figure 23. 256-Pin FineLine BGA Package Pin-Out Diagram**

Package outline not drawn to scale.



## Revision History

The information contained in the *MAX 7000A Programmable Logic Device Data Sheet* version 4.5 supersedes information published in previous versions.

### Version 4.5

The following changes were made in the *MAX 7000A Programmable Logic Device Data Sheet* version 4.5:

- Updated text in the “Power Sequencing & Hot-Socketing” section.

### Version 4.4

The following changes were made in the *MAX 7000A Programmable Logic Device Data Sheet* version 4.4:

- Added Tables 5 through 7.
- Added “Programming Sequence” on page 17 and “Programming Times” on page 18.